Features

- Fast Read Access Time 70 ns
- Low Power CMOS Operation 100 μA max. Standby 30 mA max. Active at 5 MHz
- JEDEC Standard Packages
 32-Lead 600-mil PDIP
 32-Lead 450-mil SOIC (SOP)
 32-Lead PLCC
 32-Lead TSOP
- 5V ± 10% Supply
- High Reliability CMOS Technology 2000V ESD Protection 200 mA Latchup Immunity
- Rapid[™]Programming Algorithm 100 µs/byte (typical)
- CMOS and TTL Compatible Inputs and Outputs
- Integrated Product Identification Code
- Commercial and Industrial Temperature Ranges

Description

The AT27C040 chip is a low-power, high-performance, 4,194,304-bit one-time programmable read only memory (OTP EPROM) organized as 512K by 8 bits. The AT27C040 requires only one 5V power supply in normal read mode operation. Any byte can be accessed in less than 70 ns, eliminating the need for speed reducing WAIT states on high-performance microprocessor systems.

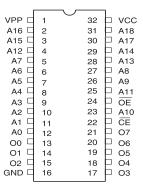
Atmel's scaled CMOS technology provides low active power consumption, and fast programming. Power consumption is typically 8 mA in active mode and less than 10 μ A in standby mode.

(continued)

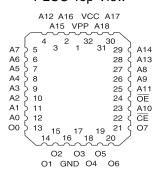
Pin Configurations

Pin Name	Function
A0 - A18	Addresses
O0 - O7	Outputs
CE	Chip Enable
ŌĒ	Output Enable

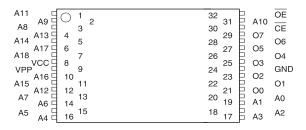
PDIP, SOIC Top View



PLCC Top View



TSOP Top View





4-Megabit (512K x 8) OTP EPROM

AT27C040

0189E-A-7/97





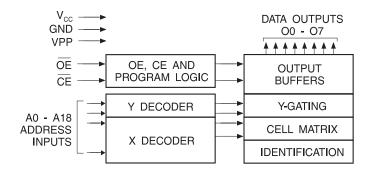
The AT27C040 is available in a choice of industry standard JEDEC-approved one-time programmable (OTP) plastic PDIP, PLCC, SOIC (SOP), and TSOP packages. The device features two-line control ($\overline{\text{CE}}$, $\overline{\text{OE}}$) to eliminate bus contention in high-speed systems.

Atmel's AT27C040 has additional features to ensure high quality and efficient production use. The Rapid[™]Programming Algorithm reduces the time required to program the part and guarantees reliable programming. Programming time is typically only 100 µs/byte. The Integrated Product Identification Code electronically identifies the device and manufacturer. This feature is used by industry standard programming equipment to select the proper programming algorithms and voltages.

Switching Considerations

Switching between active and standby conditions via the Chip Enable pin may produce transient voltage excursions. Unless accommodated by the system design, these transients may exceed data sheet limits, resulting in device non-conformance. At a minimum, a 0.1 μF high frequency, low inherent inductance, ceramic capacitor should be utilized for each device. This capacitor should be connected between the V_{CC} and Ground terminals of the device, as close to the device as possible. Additionally, to stabilize the supply voltage level on printed circuit boards with large EPROM arrays, a 4.7 μF bulk electrolytic capacitor should be utilized, again connected between the V_{CC} and Ground terminals. This capacitor should be positioned as close as possible to the point where the power supply is connected to the array.

Block Diagram



Operating Modes

Mode/Pin	CE	OE	Ai	V _{PP}	Outputs
Read	V_{IL}	V_{IL}	Ai	X ⁽¹⁾	D _{OUT}
Output Disable	Χ	V _{IH}	X	X	High Z
Standby	V _{IH}	Χ	X	X	High Z
Rapid Program ⁽²⁾	V _{IL}	V _{IH}	Ai	V _{PP}	D _{IN}
PGM Verify	Χ	V_{IL}	Ai	V_{PP}	D _{OUT}
PGM Inhibit	V _{IH}	V _{IH}	X	V_{PP}	High Z
Product Identification ⁽⁴⁾	V _{IL}	V _{IL}	$A9 = V_{H}^{(3)}$ $A0 = V_{IH} \text{ or } V_{IL}$ $A1 - A18 = V_{IL}$	Х	Identification Code

Notes: 1. X can be V_{IL} or V_{IH} .

- 2. Refer to Programming Characteristics
- 3. $V_H = 12.0 \pm 0.5 V$.
- 4. Two identifier bytes may be selected. All Ai inputs are held low (V_{IL}), except A9 which is set to V_H and A0 which is toggled low (V_{IL}) to select the Manufacturer's Identification byte and high (V_{IH}) to select the Device Code byte.

Absolute Maximum Ratings*

Temperature Under Bias	55°C to +125°C
Storage Temperature	65°C to +150°C
Voltage on Any Pin with Respect to Ground	2.0V to +7.0V ⁽¹⁾
Voltage on A9 with Respect to Ground	2.0V to +14.0V ⁽¹⁾
V _{PP} Supply Voltage with Respect to Ground	2.0V to +14.0V ⁽¹⁾

*NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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DC and AC Operating Conditions for Read Operation

			AT27C040						
		-70	-90	-12	-15				
Operating	Com.	0°C - 70°C	0°C - 70°C	0°C - 70°C	0°C - 70°C				
Temperature (Case)	Ind.	-40°C - 85°C	-40°C - 85°C	-40°C - 85°C	-40°C - 85°C				
V _{CC} Power Supply		5V ± 10%	5V ± 10%	5V ± 10%	5V ± 10%				

DC and Operating Characteristics for Read Operation

Symbol	Paramter	Condition	Min	Max	Units
I _{LI}	Input Load Current	V _{IN} = 0V to V _{CC}		±1	μΑ
I _{LO}	Output Leakage Current	V _{OUT} = 0V to V _{CC}		±5	μΑ
I _{PP1} ⁽²⁾	V _{PP} ⁽¹⁾ Read/Standby Current	$V_{PP} = V_{CC}$		10	μΑ
	V _{CC1} ⁽¹⁾ Standby Current	I_{SB1} (CMOS), $\overline{CE} = V_{CC} \pm 0.3V$		100	μΑ
I _{SB}	V _{CC1} , Standby Current	I_{SB2} (TTL), $\overline{CE} = 2.0$ to $V_{CC} + 0.5V$		1	mA
I _{CC}	V _{CC} Active Current	$f = 5 \text{ MHz}, I_{OUT} = 0 \text{ mA},$ $\overline{CE} = V_{IL}$		30	mA
V _{IL}	Input Low Voltage		-0.6	0.8	V
V _{IH}	Input High Voltage		2.0	V _{CC} + 0.5	V
V _{OL}	Output Low Voltage	I _{OL} = 2.1 mA		0.4	V
V _{OH}	Output High Voltage	I _{OH} = -400 μA	2.4		V

Notes: 1. V_{CC} must be applied simultaneously or before V_{PP} and removed simultaneously or after V_{PP}

AC Characteristics for Read Operation

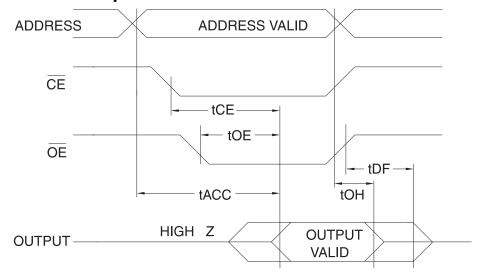
				AT27C040							
			-7	70	-6	90	-1	12	-1	15	
Symbol	Parameter	Condition	Min	Max	Min	Max	Min	Max	Min	Max	Units
t _{ACC} ⁽³⁾	Address to Output Delay	CE = OE = V _{IL}		70		90		120		150	ns
t _{CE} ⁽²⁾	CE to Output Delay	OE = V _{IL}		70		90		120		150	ns
t _{OE} ⁽²⁾⁽³⁾	OE to Output Delay	CE = V _{IL}		30		35		35		40	ns
t _{DF} ⁽⁴⁾⁽⁵⁾	OE or CE High to Output Float, whichever occurred first			20		20		30		30	ns
t _{OH}	Output Hold from Address, CE or OE, whichever occurred first		0		0		0		0		ns

Note: 2, 3, 4, 5 - see AC Waveforms for Read Operation

AT27C040 i

^{2.} V_{PP} may be connected directly to V_{CC} , except during programming. The supply current would then be the sum of I_{CC} and I_{PP}

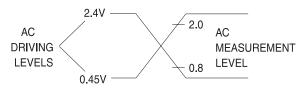
AC Waveforms for Read Operation⁽¹⁾



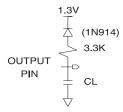
Notes: 1.

- 1. Tiiming measurement references are 0.8V and 2.0V. Input AC drive levels are 0.45V and 2.4V, unless otherwise specified.
- 2. $\overline{\text{OE}}$ may be delayed up to t_{CE} t_{OE} after the falling edge of $\overline{\text{CE}}$ without impact on t_{CE} .
- 3. OE may be delayed up to t_{ACC} t_{OE} after the address is valid without impact on t_{ACC}.
- 4. This parameter is only sampled and is not 100% tested.
- 5. Output float is defined as the point when data is no longer driven.

Input Test Waveforms and Measurement Levels



Output Test Load



Pin Capacitance

 $(f = 1 \text{ MHz}, T = 25^{\circ}\text{C})^{(1)}$

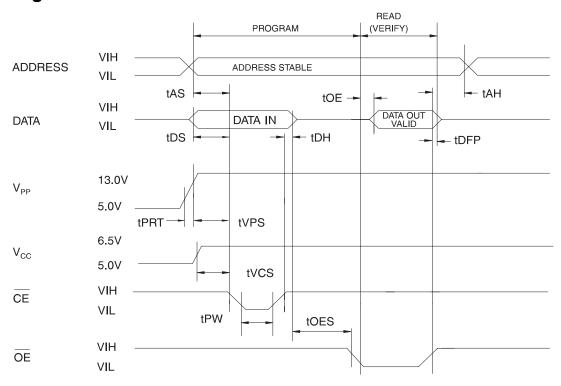
	Тур	Max	Units	Conditions
C _{IN}	4	8	pF	V _{IN} = 0V
C _{OUT}	8	12	pF	V _{OUT} = 0V

Note: 1. Typical values for nominal supply voltage. This parameter is only sampled and is not 100% tested.





Programming Waveforms⁽¹⁾



Notes: 1. The Input Timing Reference is 0.8V for $V_{\rm IL}$ and 2.0V for $V_{\rm IH}$.

- 2. t_{OE} and t_{DFP} are characteristics of the device but must be accommodated by the programmer.
- 3. When programming the AT27C040 a 0.1 μ F capacitor is required across V_{PP} and ground to supress spurious voltage transients.

DC Programming Characteristics

 $T_A = 25 \pm 5^{\circ}C, \ V_{CC} = 6.5 \pm 0.25V, \ V_{PP} = 13.0 \pm 0.25V$

			Lin	Limits	
Symbol	Parameter	Test Conditions	Min	Max	Units
I _{LI}	Input Load Current	$V_{IN} = V_{IL}, V_{IH}$		±10	μΑ
V_{IL}	Input Low Level		-0.6	0.8	V
V _{IH}	Input High Level		2.0	V _{CC} + 0.7	V
V _{OL}	Output Low Voltage	I _{OL} = 2.1 mA		0.4	V
V _{OH}	Output High Voltage	I _{OH} = -400 μA	2.4		V
I _{CC2}	V _{CC} Supply Current (Program and Verify)			40	mA
I _{PP2}	V _{PP} Supply Current	CE = V _{IL}		20	mA
V _{ID}	A9 Product Identification Voltage		11.5	12.5	V

AC Programming Characteristics

 $T_A = 25 \pm 5^{\circ}C, \ V_{CC} = 6.5 \pm 0.25V, \ V_{PP} = 13.0 \pm 0.25V$

			Lin		
Symbol	Parameter	Test Conditions ⁽¹⁾	Min	Max	Units
t _{AS}	Address Setup Time		2		μs
t _{OES}	OE Setup Time	Input Rise and Fall Times	2		μs
t _{DS}	Data Setup Time	(10% to 90%) 20ns			μs
t _{AH}	Address Hold Time	Land B. Inc. Lands	0		μs
t _{DH}	Data Hold Time	Input Pulse Levels 0.45V to 2.4V			μs
t _{DFP}	OE High to Output Float Delay ⁽²⁾		0	130	ns
t _{VPS}	V _{PP} Setup Time	Input Timing Reference Level 0.8V to 2.0V	2		μs
t _{VCS}	V _{CC} Setup Time	0.67 10 2.07	2		μs
t _{PW}	CE Program Pulse Width ⁽³⁾	Output Timing Reference Level	95	105	μs
t _{OE}	Data Valid from $\overline{OE}^{(2)}$	0.8V to 2.0V		150	ns
t _{PRT}	V _{PP} Pulse Rise Time During Programming		50		ns

- Notes: 1. V_{CC} must be applied simultaneously or before V_{PP} and removed simultaneously or after V_{PP}
 - 2. This parameter is only sampled and is not 100% tested. Output Float is defined as the point where data is no longer driven see timing diagram.
 - 3. Program Pulse width tolerance is 100 $\mu sec \pm 5\%.$

Atmel's 27C040 Integrated Product Identification Code

		Pins						Hey Date		
Codes	Α0	07	O 6	O5	04	О3	02	01	00	Hex Data
Manufacturer	0	0	0	0	1	1	1	1	0	1E
Device Type	1	0	0	0	0	1	0	1	1	0B

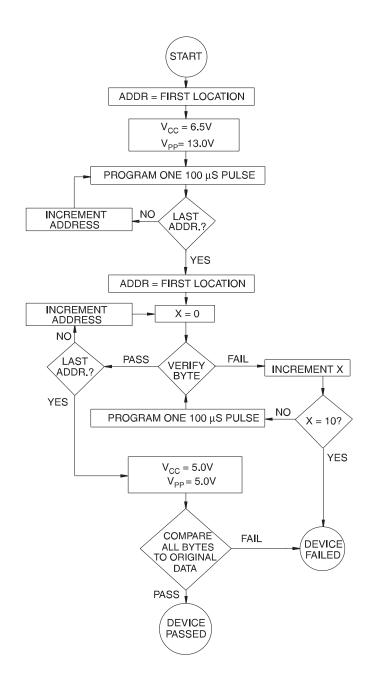




Rapid Programming Algorithm

A 100 μs \overline{CE} pulse width is used to program. The address is set to the first location. V_{CC} is raised to 6.5V and V_{PP} is raised to 13.0V. Each address is first programmed with one 100 μs \overline{CE} pulse without verification. Then a verification/reprogramming loop is executed for each address. In the event a byte fails to pass verification, up to 10 successive 100 μs pulses are applied with a verification after each

pulse. If the byte fails to verify after 10 pulses have been applied, the part is considered failed. After the byte verifies properly, the next address is selected until all have been checked. V_{PP} is then lowered to 5.0V and V_{CC} to 5.0V. All bytes are read again and compared with the original data to determine if the device passes or fails.



Ordering Information

	I _{cc}	(mA)			
t _{ACC} (ns)	Active	Standby	Ordering Code	Package	Operation Range
70	30	0.1	AT27C040-70JC	32J	Commercial
			AT27C040-70PC	32P6	(0°C to 70°C)
			AT27C040-70RC	32R	
			AT27C040-70TC	32T	
	30	0.1	AT27C040-70JI	32J	Industrial
			AT27C040-70PI	32P6	(-40°C to 85°C)
			AT27C040-70RI	32R	
			AT27C040-70TI	32T	
90	30	0.1	AT27C040-90JC	32J	Commercial
			AT27C040-90PC	32P6	(0°C to 70°C)
			AT27C040-90RC	32R	
			AT27C040-90TC	32T	
	30	0.1	AT27C040-90JI	32J	Industrial
			AT27C040-90PI	32P6	(-40°C to 85°C)
			AT27C040-90RI	32R	
			AT27C040-90TI	32T	
120	30	0.1	AT27C040-12JC	32J	Commercial
			AT27C040-12PC	32P6	(0°C to 70°C)
			AT27C040-12RC	32R	
			AT27C040-12TC	32T	
	30	0.1	AT27C040-12JI	32J	Industrial
			AT27C040-12PI	32P6	(-40°C to 85°C)
			AT27C040-12RI	32R	
			AT27C040-12TI	32T	
150	30	0.1	AT27C040-15JC	32J	Commercial
			AT27C040-15PC	32P6	(0°C to 70°C)
			AT27C040-15RC	32R	
			AT27C040-15TC	32T	
	30	0.1	AT27C040-15JI	32J	Industrial
			AT27C040-15PI	32P6	(-40°C to 85°C)
			AT27C040-15RI	32R	
			AT27C040-15TI	32T	

	Package Type				
32J	32-Lead, Plastic J-Leaded Chip Carrier (PLCC)				
32P6	32-Lead, 0.600" Wide, Plastic Dual Inline Package (PDIP)				
32R	32-Lead, 0.450" Wide, Plastic Gull Wing Small Outline (SOIC)				
32T	32-Lead, Plastic Thin Small Outline Package (TSOP)				

